5V/3.2A 150KHz 40V Buck DC to DC Converter For USB Interface

XL2013

Features

- Wide 8V to 40V input voltage range
- Fixed 5V output voltage
- Maximum 3.2A output current
- Fixed 150KHz switching frequency
- Internal optimize power MOSFET
- High efficiency up to 92%
- Built in output short shutdown function
- Excellent line and load regulation
- Built in thermal shutdown function
- Built in current limit function
- Available in TO252-5L package

General Description

The XL2013 is a 150KHz fixed frequency PWM buck (step-down) DC/DC converter, capable of driving a 3.2A load with high efficiency, low ripple and excellent line and load regulation. Requiring a minimum number of external components, the regulator is simple to use and include internal frequency compensation and a fixed-frequency oscillator.

The XL2013 built in output short protection function. When short protection function happens, the chip will be shutdown. An internal compensation block is built in to minimize external component count.

Applications

- Car Charger
- Battery Charger
- USB Power Supply



Figure1. Package Type of XL2013

XL2013

Pin Configurations

TO252-5L

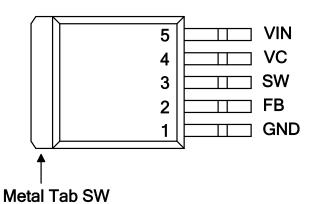


Figure 2. Pin Configuration of XL2013 (Top View)

Table 1 Pin Description

Pin Number	Pin Name	Description
1	GND	Ground Pin. Care must be taken in layout. This pin should be placed outside of the Schottky Diode to output capacitor ground path to prevent switching current spikes from inducing voltage noise into XL2013.
2	FB	Feedback Pin (FB). The feedback threshold voltage is 5V.
3	SW	Power Switch Output Pin (SW). SW is the switch node that supplies power to the output.
4	VC	Internal Voltage Regulator Bypass Capacitor Pin (VC). The VC pin connect a 1uf capacitor to VIN.
5	VIN	Supply Voltage Input Pin. XL2013 operates from 8V to 40V DC voltage. Bypass Vin to GND with a suitably large capacitor to eliminate noise on the input.



5V/3.2A 150KHz 40V Buck DC to DC Converter For USB Interface

XL2013

Function Block

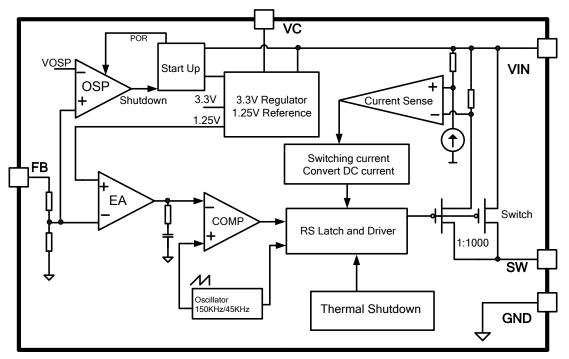


Figure 3. Function Block Diagram of XL2013

Typical Application Circuit

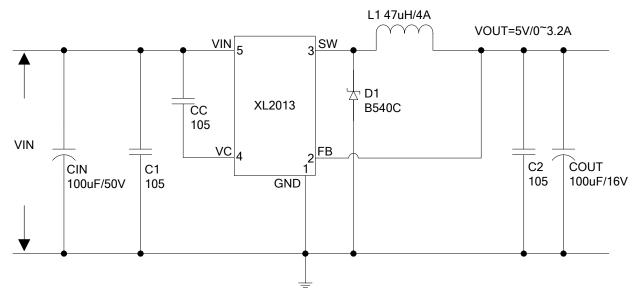


Figure 4. XL2013 Typical Application Circuit (VIN=8V~40V, VOUT=5V/3.2A)

XL2013

Ordering Information

Order Information	Marking ID	Package Type	Packing Type Supplied As
XL2013E1	XL2013E1	TO252-5L	2500 Units on Tape & Reel

XLSEMI Pb-free products, as designated with "E1" suffix in the par number, are RoHS compliant.

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit	
Input Voltage	Vin	-0.3 to 45	V	
Feedback Pin Voltage	V_{FB}	–0.3 to Vin	V	
Output Switch Pin Voltage	V_{SW}	–0.3 to Vin	V	
Power Dissipation	PD	Internally limited	mW	
Thermal Resistance (TO252-5L)	D	50	°C/W	
(Junction to Ambient, No Heatsink, Free Air)	Rja	50		
Operating Junction Temperature	TJ	T _J -40 to 125		
Storage Temperature	T _{STG}	-65 to 150	Ĵ	
Lead Temperature (Soldering, 10 sec)	TLEAD	260	C	
ESD (HBM)		>2000	V	

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

XL2013

XL2013 Electrical Characteristics

 $T_a = 25^{\circ}$; unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit	
System parameters test circuit figure4							
VFB	Feedback Voltage	Vin = 8V to 40V, Vout=5V Iload=0.5A to 3.2A	4.9 5		5.1	V	
η	Efficiency	Vin=12V,Vout=5V lout=3.2A	-	87	_	%	

Electrical Characteristics (DC Parameters)

Vin = 12V, GND=0V, Vin & GND parallel connect a 100 μ F/50V capacitor; lout=500mA, T_a = 25°C; the others floating unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Input operation voltage	Vin		8		40	V
Quiescent Supply Current	l _q	V_{FB} =Vin		4.7	10	mA
Output Short Supply Current	losp				5	mA
Oscillator Frequency	Fosc		127	150	173	KHz
Switch Current Limit	١L	V _{FB} =0V		3.5		А
Output Power PMOS	Rdson	V _{FB} =0V, Vin=12V, I _{sw} =3.2A		70	90	mohm

5V/3.2A 150KHz 40V Buck DC to DC Converter For USB Interface

XL2013

Typical System Application (VOUT=5V/3.2A)

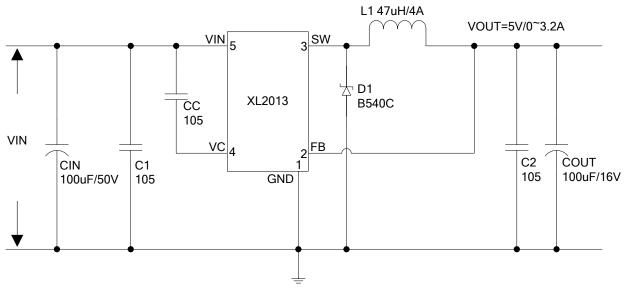


Figure 5. XL2013 System Parameters Test Circuit (VIN=8V~40V, VOUT=5V/3.2A)

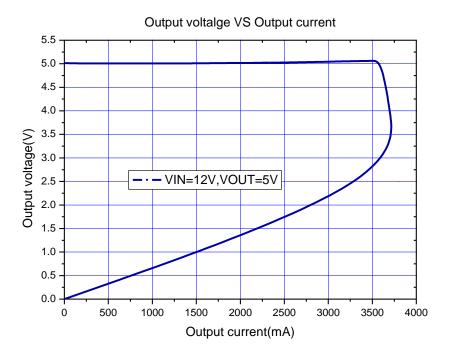


Figure6. XL2013 System Output Constant Current Curve



5V/3.2A 150KHz 40V Buck DC to DC Converter For USB Interface

XL2013

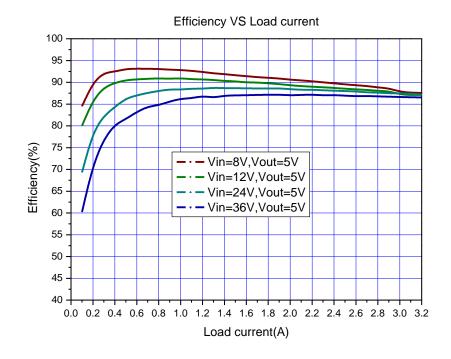


Figure 7. XL2013 System Efficiency Curve

XL2013

Output short shutdown

The output short shutdown function is built in XL2013. The short protection circuit monitors the output voltage, whenever FB pin voltage is below 1.5V, the short circuit protection circuit is triggered, the converter will be shutdown, input current less than 5mA.

When the short fault is removed, if output load is floating, then converter will restart up, the output voltage will return to normal; if output load isn't floating, then converter must be power reset, the output voltage will comeback.

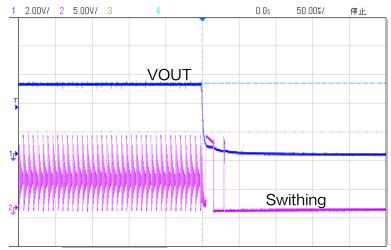


Figure 8. The converter will be shutdown when output short happen.

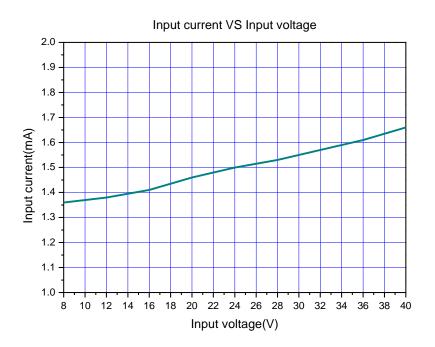


Figure 9. The input current curve when output short happen.

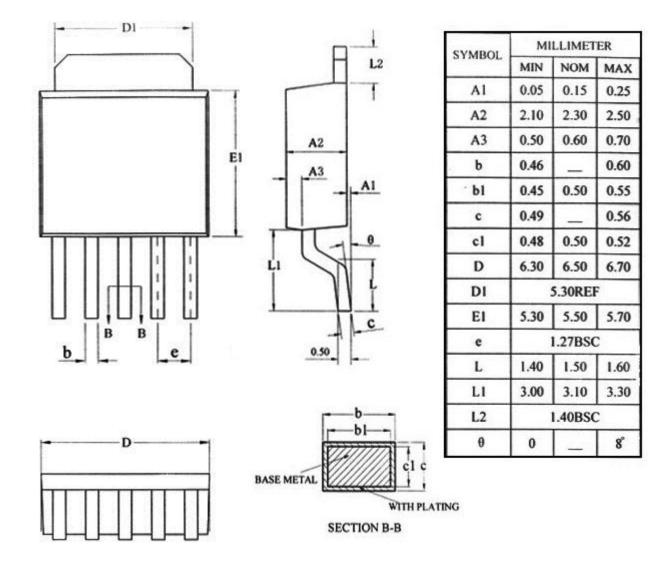
XLSEMI

5V/3.2A 150KHz 40V Buck DC to DC Converter For USB Interface

XL2013

Package Information

TO252-5L Mechanical Dimensions



XL2013

Important Notice

XLSEMI reserve the right to make modifications, enhancements, improvements, corrections or other changes without notice at any time. XLSEMI does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. XLSEMI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using XLSEMI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards. XLSEMI warrants performance of its products to the specifications applicable at the time of sale, in accordance with the warranty in XLSEMI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent XLSEMI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed. For the latest product information, go to www.xlsemi.com.